

# STCS1

## 1.5 A max constant current LED driver

The STCS1 is a BiCMOS constant current source designed to provide a precise constant current starting from a varying input voltage source. The main target is to replace discrete components solution for driving LEDs in low voltage applications such as 5 V, 12 V or 24 V giving

benefits in terms of precision, integration and

implementing PWM dimming.

load disconnection condition.

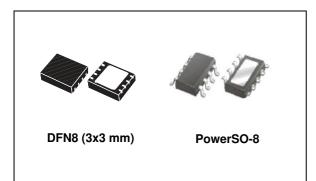
The current is set with external resistor up to 1.5 A with a  $\pm$  10 % precision; a dedicated pin allows

An open-drain pin output provides information on

Description

reliability.

#### Datasheet - production data



### **Features**

- Up to 40 V input voltage
- Less than 0.5 V voltage overhead
- Up to 1.5 A output current
- PWM dimming pin
- Shutdown pin
- LED disconnection diagnostic

## **Applications**

- Supplying LEDs with constant current for varying input voltages
- Low voltage lighting
- Small appliance LED lighting

#### Table 1. Device summary

Order codes	Packages	Packaging
STCS1PUR	DFN8 (3 x 3 mm)	3000 parts per reel
STCS1PHR	PowerSO-8	2500 parts per reel

This is information on a product in full production.

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## 1 Application diagram

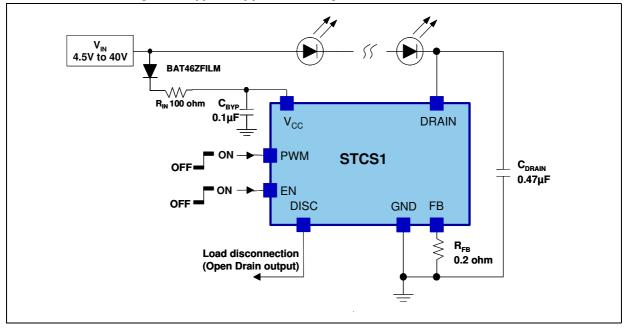
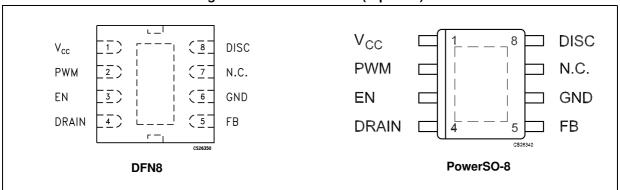


Figure 1. Typical application diagram for 0.5 A LED current



## 2 Pin configuration



### Figure 2. Pin connections (top view)

### Table 2. Pin description

Pin n°	Symbol	Note
1	V <sub>CC</sub>	Supply voltage
2	PWM	PWM dimming input
3	EN	Shutdown pin
4	DRAIN	Internal N-MOSFET drain
5	FB	Feedback input. The control loop regulates the current in such a way that the average voltage at the FB input is 100 mV (nominal). The cathode of the LED and a resistor to ground to set the LED current should be connected at this point
6	GND	Ground
7	N.C.	In order to guarantee the device works properly it is mandatory to leave this pin floating
8	DISC	Load disconnection flag (open drain)
	Exp-pad	Internally connected to ground



#### **Maximum ratings** 3

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC supply voltage	-0.3 to +45	v
DRAIN	Drain pin	-0.3 to +45	v
PWM, EN, DISC	Logic pins	-0.3 to + V <sub>CC</sub> + 0.3	V
FB	Configuration pins	-0.3 to + 3.3	V
ESD	Human body model (all pins)	±2	kV
T <sub>J</sub> <sup>(1)</sup>	Junction temperature	-40 to 150	°C
T <sub>STG</sub>	Storage temperature range	-55 to 150	°C

#### Table 3. Absolute maximum ratings

T<sub>J</sub> is calculated from the ambient temperature T<sub>A</sub> and the power dissipation P<sub>D</sub> according the following formula: T<sub>J</sub> = T<sub>A</sub> + (P<sub>D</sub> x R<sub>thJA</sub>). See *Figure 12* and *Figure 13* for details of max power dissipation for ambient temperatures higher than 25°C.

#### Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

#### Table 4. Thermal data

Symbol	Parameter	DFN8	PowerSO-8	Unit
R <sub>thJC</sub>	Thermal resistance junction-case	10	12	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	37.6 <sup>(1)</sup>	45 <sup>(2)</sup>	°C/W

1. This value is referred to four-layer PCB, JEDEC standard test board.

2. With two sides, two planes PCB following EIA/JEDEC JESD51-7 standard.



## 4 Electrical characteristics

 $V_{CC}$  = 12 V;  $I_O$  = 100 mA;  $T_J$  = -40 °C to 125 °C;  $V_{DRAIN}$  = 1 V;  $C_{DRAIN}$  = 1  $\mu$ F;  $C_{BYP}$  = 100 nF typical values are at  $T_A$  = 25 °C, unless otherwise specified.

		Electrical characteristics		-			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V <sub>CC</sub>	Supply voltage range		4.5		40	V	
	Output current range		1		1500	mA	
Ι <sub>Ο</sub>	Output current	R <sub>FB</sub> = 0.2 Ω		500		mA	
	Regulation (percentage with respect to $V_{CC}$ =12V)	V <sub>CC</sub> = 4.5 to 40 V, I <sub>O</sub> = 100 mA; V <sub>DRAIN</sub> = 1 V	-1		+1	%	
$V_{FB}$	Feedback voltage	I <sub>O</sub> = 0 to 1.5A	90	100	110	mV	
		On Mode		450	750		
I <sub>CC</sub>	Quiescent current (Measured on $V_{CC}$ pin)	Shutdown Mode; $V_{CC} = 5$ to 12V			1	μA	
		Shutdown Mode; $V_{CC} = 12 \text{ to } 40 \text{V}$			3		
M		I <sub>O</sub> = 100 mA		0.12	0.16	- V	
V <sub>DROP</sub>	Dropout voltage (V <sub>DRAIN</sub> to GND)	I <sub>O</sub> = 1.5 A		0.58	0.9		
LEAK <sub>DRAIN</sub>	Drain leakage current	Shutdown; V <sub>DRAIN</sub> = 40 V			10	μA	
T <sub>D</sub>	Delay on PWM signal	$V_{PWM}$ rising, $V_{CC}$ = 12 V		3		μs	
	(see Figure 3)	$V_{PWM}$ falling, $V_{CC}$ = 12 V		1.2			
	Low level voltage	I <sub>SINK</sub> = 5 mA		0.2	0.5	V	
DISC	Leakage current	V <sub>DISC</sub> = 5 V			1	μA	
DISC	Load disconnection threshold	DISC Turn-ON		75			
	(V <sub>DRAIN</sub> -GND)	DISC Turn-OFF		110		mV	
Thermal	Shutdown temperature			155			
Protection	Hysteresis			25		°C	
Logic input	s (PWM and EN)						
VL	Input low level				0.4	V	
V <sub>H</sub>	Input high level		1.2			V	
	EN, PWM leakage current	V <sub>EN</sub> = 5 V; V <sub>PWM</sub> = 5 V			2		
	EN input leakage current	V <sub>EN</sub> = 40 V			60	μA	
	PWM input leakage current	V <sub>PWM</sub> = 40 V			120		

Note: All devices 100 % production tested at  $T_A = 25$  °C. Limits over the operating temperature range are guaranteed by design.

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# 5 Timing

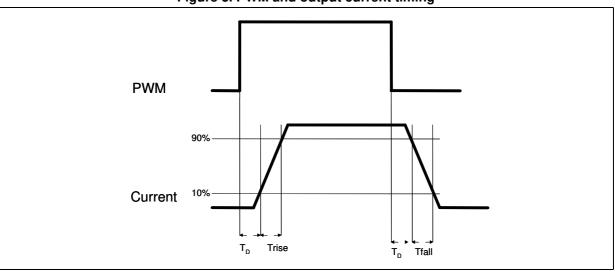
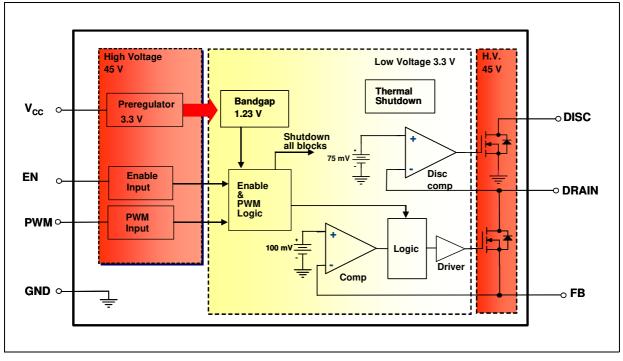


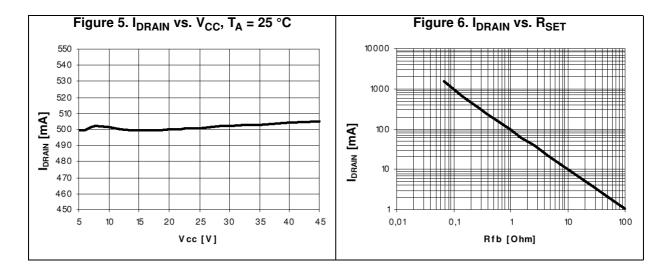
Figure 3. PWM and output current timing

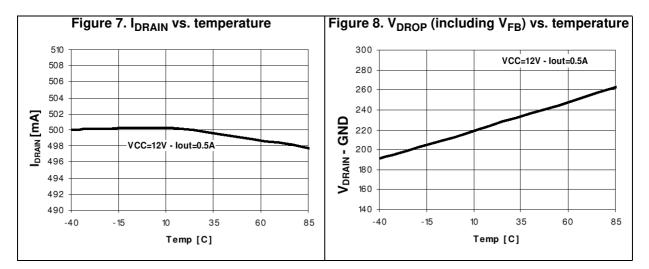
### Figure 4. Block diagram

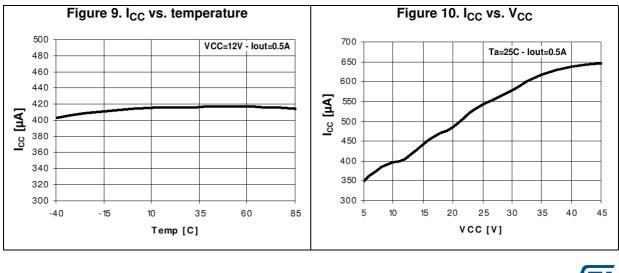




## 6 Typical performance characteristics







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## 7 Detail description

The STCS1 is a BiCMOS constant current source designed to provide a precise constant current starting from a varying input voltage source. The main target is to replace discrete components solution for driving LEDs in low voltage applications such as 5 V, 12 V or 24 V giving benefits in terms of precision, integration and reliability.

### 7.1 Current setting

The current is set with an external sensing resistor connected to the FB pin. The feedback voltage is 100 mV, then a low resistor value can be chosen reducing power dissipation. A value between 1 mA and 1.5 A can be set according to the resistor value, the resulting output current has a tolerance of  $\pm$  10 %.

For instance, should one need a 700 mA LEDs current,  $R_F$  should be selected according to the following equation:

 $R_F$  =  $V_{FB}$  /  $I_{LEDs}$  = 100 mV / 700 mA = 142 m $\Omega$ 

### 7.2 Enable

When the enable pin is low the device completely off thus reducing current consumption to less than 1  $\mu A.$  When in shutdown mode, the internal main switch is off.

### 7.3 PWM dimming

The PWM input allows implementing PWM dimming on the LED current; when the PWM input is high the main switch will be on and vice versa. A typical frequency range for the input is from few hertz to 50 kHz. The maximum dimming frequency is limited by the minimum rise/fall time of the current which is around 4  $\mu$ s each. Above 50 kHz the current waveforms starts assuming a triangular shape.

While the PWM input is switching, the overall circuitry remains on, this is needed in order to implement a short delay time TD (see *Figure 3*).

Since the PWM pin is controlling just the main switch, the overall circuitry is always on and it is able to control the delay time between the PWM input signal and the output current in the range of few  $\mu$ s, this is important to implement synchronization among several light LED sources.

## 7.4 Diagnostic

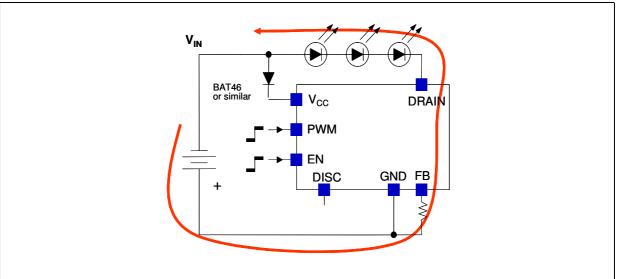
When STCS1 is in on mode (EN is high), the device is able to detect disconnection or fail of the LED string monitoring  $V_{DRAIN}$  pin. If  $V_{DRAIN}$  is lower than 75 mV the DISC pin is pulled low regardless the PWM pin status. This information can be used by the system to inform that some problem happens in the LEDs.

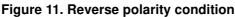


## 8 Application information

### 8.1 Reverse polarity protection

STCS1 must be protected from reverse connection of the supply voltage. Since the current sunk from V<sub>CC</sub> pin is in the range of 450  $\mu$ A a small diode connected to V<sub>CC</sub> is able to protect the chip. Care must be taken for the whole application circuit, especially for the LEDs, in fact, in case a negative voltage is applied between V<sub>IN</sub> and GND, a negative voltage will be applied to the LED string that must have a total breakdown voltage higher than the negative applied voltage in order to avoid any damage.





## 8.2 Thermal considerations

The STCS1 is able to control a LED current up to 1.5 A and able to sustain a voltage on the drain pin up to 40 V. Those operating conditions are however limited by thermal constraints, the thermal resistances shown in the *Table 4: Thermal data* section are the typical ones, in particular R<sub>thJA</sub> depends on the copper area and the number of layers of the printed circuit board under the pad. DFN8 and PowerSO-8 have an exposed die attach pad which enhances the thermal conductivity enabling high power application.

The power dissipation in the device can be calculated as follow:

 $\mathsf{P}_\mathsf{D} = (\mathsf{V}_\mathsf{DRAIN} - \mathsf{V}_\mathsf{FB}) \times \mathsf{I}_\mathsf{LED} + (\mathsf{V}_\mathsf{CC} \times \mathsf{I}_\mathsf{CC})$ 

basing on this and on the thermal resistance and ambient temperature, the junction temperature can be calculated as:

 $T_J = R_{thJA} \times P_D + T_A$ 

A typical application could be:

- Input Voltage: 12 V;
- 3 white LEDs with an typical  $V_F = 3.6 V$ ;



- LEDs current: 500 mA;
- Package: DFN8 3x3 mm;
- $T_A = 50 °C;$

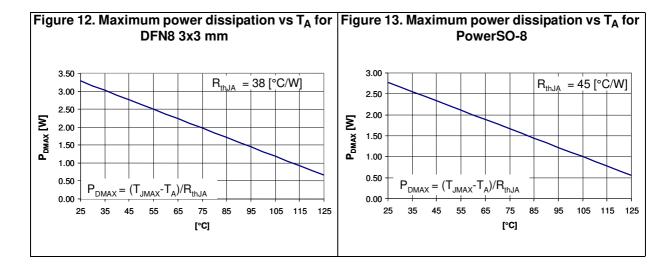
In this case  $V_{DRAIN} = 12 - 3 \times 3.6 = 1.2 \text{ V}$ 

 $P_D = (1.2 - 0.1) \times 0.5 + 12 \times 0.5 \times 10^{-3} = 0.55 + 6 \times 10^{-3} = 556 \text{ mW}$ 

The junction temperature will be:

T<sub>.1</sub> = 37.6 x 0.556 + 50 = 70.9 °C.

The following pictures show the maximum power dissipation according to the ambient temperature for both packages:



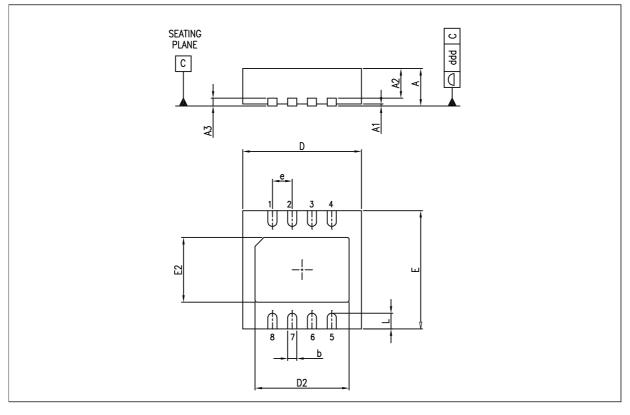


# 9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

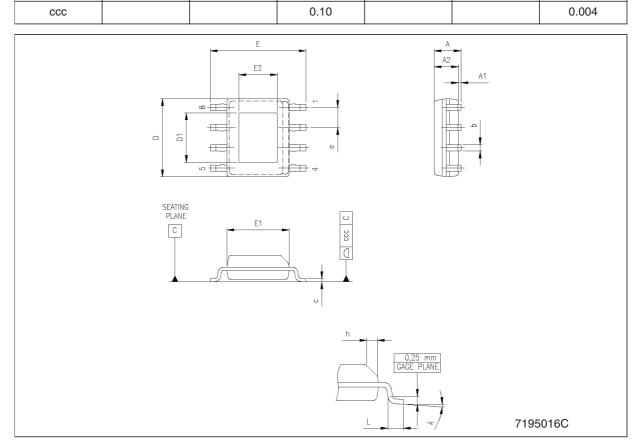


	DFN8 (3x3 mm) mechanical data						
		mm.			mils.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.80	0.90	1.00	31.5	35.4	39.4	
A1		0.02	0.05		0.8	2.0	
A2		0.70			27.6		
A3		0.20			7.9		
b	0.18	0.23	0.30	7.1	9.1	11.8	
D		3.00			118.1		
D2	2.23	2.38	2.48	87.8	93.7	97.7	
E		3.00			118.1		
E2	1.49	1.64	1.74	58.7	64.6	68.5	
е		0.50			19.7		
L	0.30	0.40	0.50	11.8	15.7	19.7	





PowerSO-8 mechanical data							
<b>D</b> :		mm.			inch.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.70			0.067	
A1	0.00		0.15	0.00		0.006	
A2	1.25			0.049		0.142	
b	0.31		0.51	0.012		0.020	
С	0.17		0.25	0.007		0.010	
D	4.80	4.90	5.00	0.189	0193	0.197	
D1	2.24	3.10	3.20	0.088	0.122	0.126	
Е	5.80	6.00	6.20	0.228	0.236	0.244	
E1	3.80	3.90	4.00	0.150	0.154	0.157	
E2	1.55	2.41	2.51	0.061	0.095	0.099	
е		1.27			0.050		
h	0.25		0.50	0.010		0.020	
L	0.40		1.27	0.016		0.050	
k	0°		8°	0°		8°	



### PowerSO-8 mechanical data

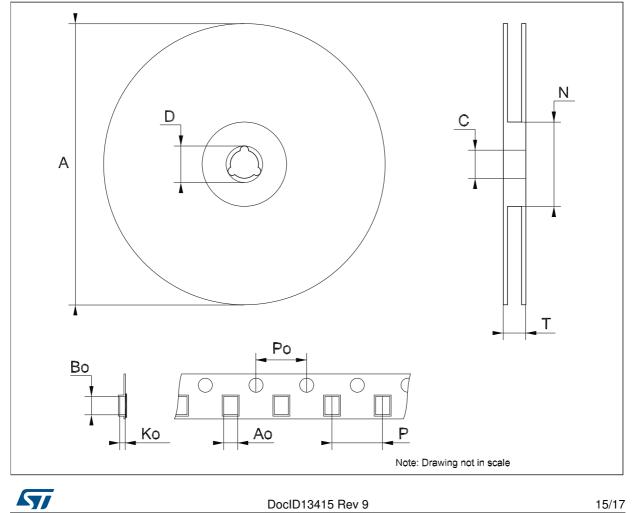


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Dim.		mm.			inch.	
Dini.	Min.	Тур.	Max.	Min.	Тур.	Max.
А			180			7.087
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
т			14.4			0.567
Ao		3.3			0.130	
Во		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	



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# 10 Revision history

Date	Revision	Changes	
10-Apr-2007	1	Initial release.	
07-May-2007	2	PowerSO-8 mechanical data has been updated and the ${\sf R}_{thJC}$ for PowerSO-8 value on Table 4 is changed.	
24-May-2007	3	Change value $C_{BYP} 0.1 \ \mu F ==> 1 \ \mu F$ on Figure 1 typical application.	
27-Sep-2007	4	Add R <sub>IN</sub> on Figure 1 application diagram.	
02-Oct-2007	5	Figure 1 updated.	
15-Feb-2008	6	Modified: Figure 1, Figure 4, Figure 12, Figure 13.	
05-May-2008	7	Modified: Table 2, pin 7 description.	
02-Jul-2008	8	Modified: Table 5.	
20-Jan-2022	9	Updated: Applications on the cover page.	

#### Table 6. Document revision history



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